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Details

Product Status	Obsolete
Core Processor	-
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Number of I/O	-
Program Memory Size	-
Program Memory Type	-
EEPROM Size	-
RAM Size	-
Voltage - Supply (Vcc/Vdd)	-
Data Converters	-
Oscillator Type	-
Operating Temperature	-
Mounting Type	-
Package / Case	-
Supplier Device Package	-
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/m30291fathp-u3aai1

Quick Reference to Pages Classified by Address

Address	Register	Symbol	Page
0180 ₁₆			
0181 ₁₆			
0182 ₁₆			
0183 ₁₆			
0184 ₁₆			
0185 ₁₆			
0186 ₁₆			
01B0 ₁₆			
01B1 ₁₆			
01B2 ₁₆			
01B3 ₁₆	Flash memory control register 4 (Note 2)	FMR4	342
01B4 ₁₆			
01B5 ₁₆	Flash memory control register 1 (Note 2)	FMR1	341
01B6 ₁₆			
01B7 ₁₆	Flash memory control register 0 (Note 2)	FMR0	341
01B8 ₁₆			
01B9 ₁₆			
01BA ₁₆			
01BB ₁₆			
01BC ₁₆			
0200 ₁₆	CAN0 message control register 0	C0MCTL0	292
0201 ₁₆	CAN0 message control register 1	C0MCTL1	292
0202 ₁₆	CAN0 message control register 2	C0MCTL2	292
0203 ₁₆	CAN0 message control register 3	C0MCTL3	292
0204 ₁₆	CAN0 message control register 4	C0MCTL4	292
0205 ₁₆	CAN0 message control register 5	C0MCTL5	292
0206 ₁₆	CAN0 message control register 6	C0MCTL6	292
0207 ₁₆	CAN0 message control register 7	C0MCTL7	292
0208 ₁₆	CAN0 message control register 8	C0MCTL8	292
0209 ₁₆	CAN0 message control register 9	C0MCTL9	292
020A ₁₆	CAN0 message control register 10	C0MCTL10	292
020B ₁₆	CAN0 message control register 11	C0MCTL11	292
020C ₁₆	CAN0 message control register 12	C0MCTL12	292
020D ₁₆	CAN0 message control register 13	C0MCTL13	292
020E ₁₆	CAN0 message control register 14	C0MCTL14	292
020F ₁₆	CAN0 message control register 15	C0MCTL15	292
0210 ₁₆			
0211 ₁₆	CAN0 control register	C0CTLR	293
0212 ₁₆			
0213 ₁₆	CAN0 status register	C0STR	294
0214 ₁₆			
0215 ₁₆	CAN0 slot status register	C0SSTR	295
0216 ₁₆			
0217 ₁₆	CAN 0 interrupt control register	C0ICR	296
0218 ₁₆			
0219 ₁₆	CAN0 extended ID register	C0IDR	296
021A ₁₆			
021B ₁₆	CAN0 configuration register	C0CONR	297
021C ₁₆	CAN0 receive error count register	C0RECR	298
021D ₁₆	CAN0 transmit error count register	C0TECR	298
021E ₁₆			
021F ₁₆	CAN0 time stamp register	C0TSR	299
0210 ₁₆			
02FE ₁₆			
02FF ₁₆			

Note 1: The blank areas are reserved and cannot be accessed by users.

Note 2: This register is included in the flash memory version.

[illegible]

Table 1.5 Product List (3) -V Version**As of March, 2007**

Type Number	ROM Capacity	RAM Capacity	Package Type	Remarks	Product Code
M30290FAVHP	96 K + 4 K	8 K	PLQP0080KB-A (80P6Q-A)	Flash Memory	U3, U5, U7, U9
M30290FCVHP	128 K + 4 K	12 K			
M30291FAVHP	96 K + 4 K	8 K	PLQP0064KB-A (64P6Q-A)		
M30291FCVHP	128 K + 4 K	12 K			
M30290M8V-XXXHP	64 K	4 K	PLQP0080KB-A (80P6Q-A)	Mask ROM	U0
M30290MAV-XXXHP	96 K	8 K			
M30290MCV-XXXHP	128 K	12 K			
M30291M8V-XXXHP	64 K	4 K	PLQP0064KB-A (64P6Q-A)		
M30291MAV-XXXHP	96 K	8 K			
M30291MCV-XXXHP	128 K	12 K			

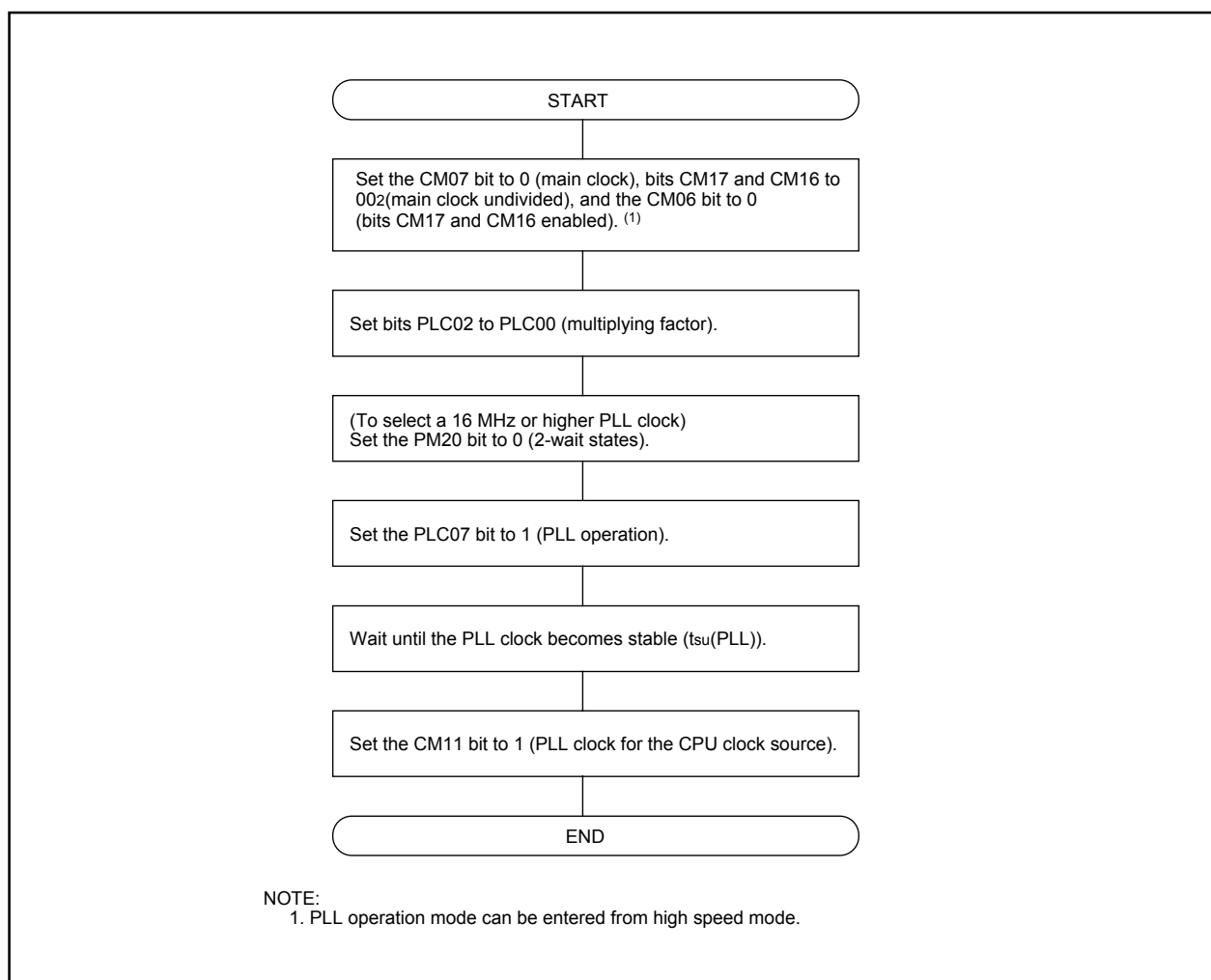
**Figure 7.10 Procedure to Use PLL Clock as CPU Clock Source**

Figure 7.11 shows the state transition from normal operation mode to stop mode and wait mode. **Figure 7.12** shows the state transition in normal operation mode.

Table 7.7 shows a state transition matrix describing allowed transition and setting. The vertical line shows current state and horizontal line shows state after transition.

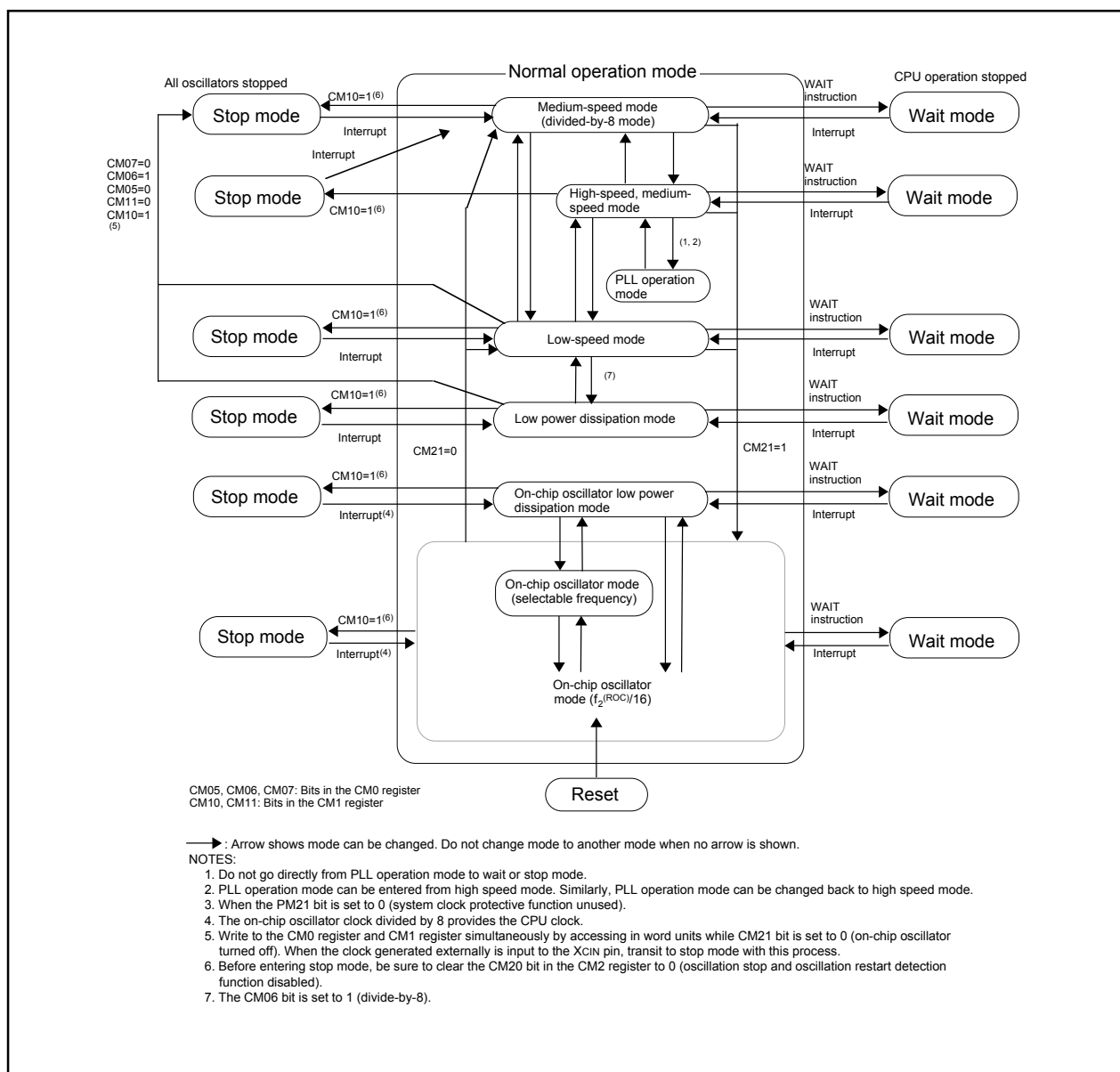


Figure 7.11 State Transition to Stop Mode and Wait Mode

9.3.1 I Flag

The I flag enables or disables the maskable interrupt. Setting the I flag to 1 (= enabled) enables the maskable interrupt. Setting the I flag to 0 (= disabled) disables all maskable interrupts.

9.3.2 IR Bit

The IR bit is set to 1 (= interrupt requested) when an interrupt request is generated. Then, when the interrupt request is accepted and the CPU branches to the corresponding interrupt vector, the IR bit is cleared to 0 (= interrupt not requested).

The IR bit can be cleared to 0 in a program. Note that do not write 1 to this bit.

9.3.3 ILVL2 to ILVL0 Bits and IPL

Interrupt priority levels can be set using bits ILVL2 to ILVL0.

Table 9.3 shows the settings of interrupt priority levels and **Table 9.4** shows the interrupt priority levels enabled by the IPL.

The following are conditions under which an interrupt is accepted:

- I flag = 1
- IR bit = 1
- interrupt priority level > IPL

The I flag, IR bit, bits ILVL2 to ILVL0, and IPL are independent of each other. In no case do they affect one another.

Table 9.3 Settings of Interrupt Priority Levels

ILVL2 to ILVL0 bits	Interrupt priority level	Priority order
0002	Level 0 (interrupt disabled)	———
0012	Level 1	<div style="text-align: center;"> Low ↓ High </div>
0102	Level 2	
0112	Level 3	
1002	Level 4	
1012	Level 5	
1102	Level 6	
1112	Level 7	

Table 9.4 Interrupt Priority Levels Enabled by IPL

IPL	Enabled interrupt priority levels
0002	Interrupt levels 1 and above are enabled
0012	Interrupt levels 2 and above are enabled
0102	Interrupt levels 3 and above are enabled
0112	Interrupt levels 4 and above are enabled
1002	Interrupt levels 5 and above are enabled
1012	Interrupt levels 6 and above are enabled
1102	Interrupt levels 7 and above are enabled
1112	All maskable interrupts are disabled

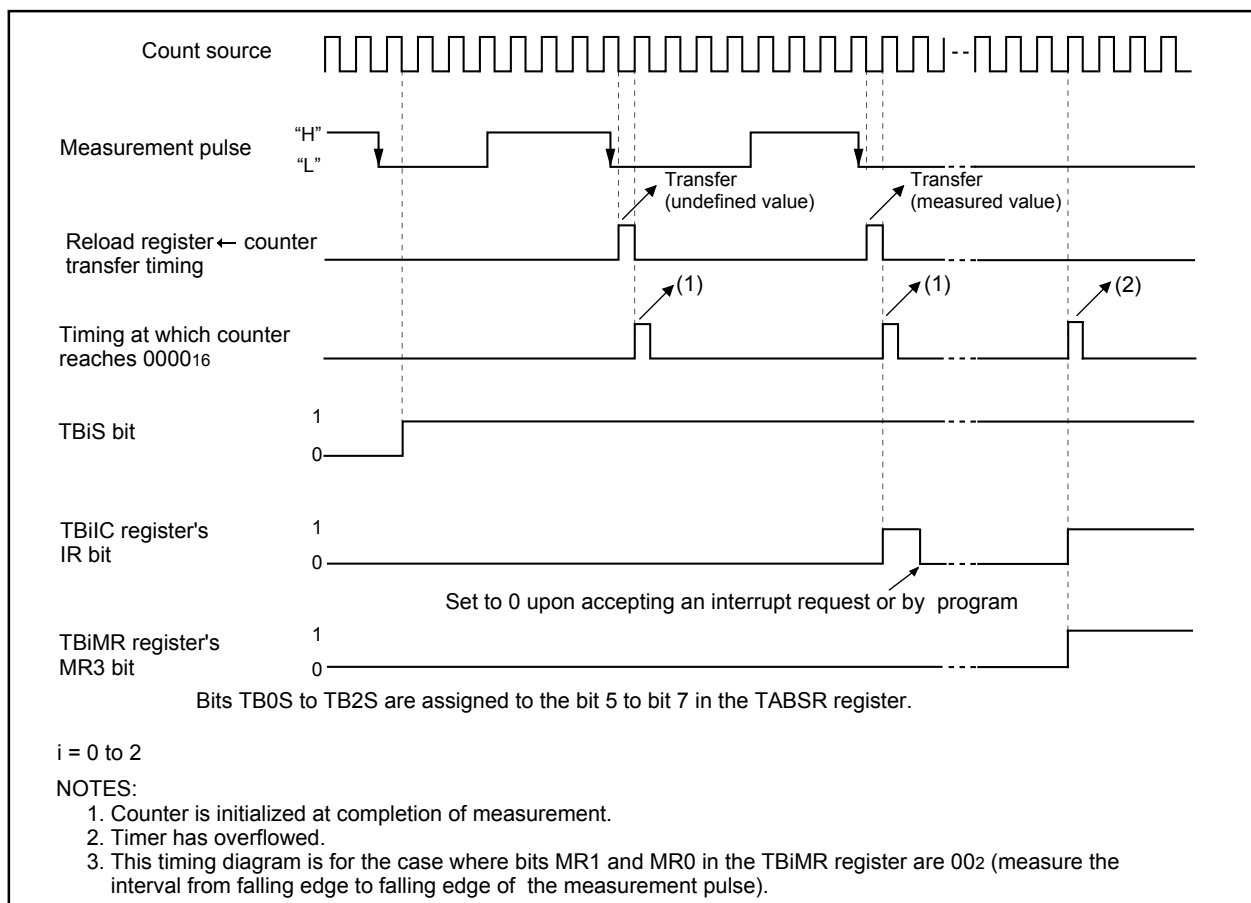


Figure 12.21 Operation timing when measuring a pulse period

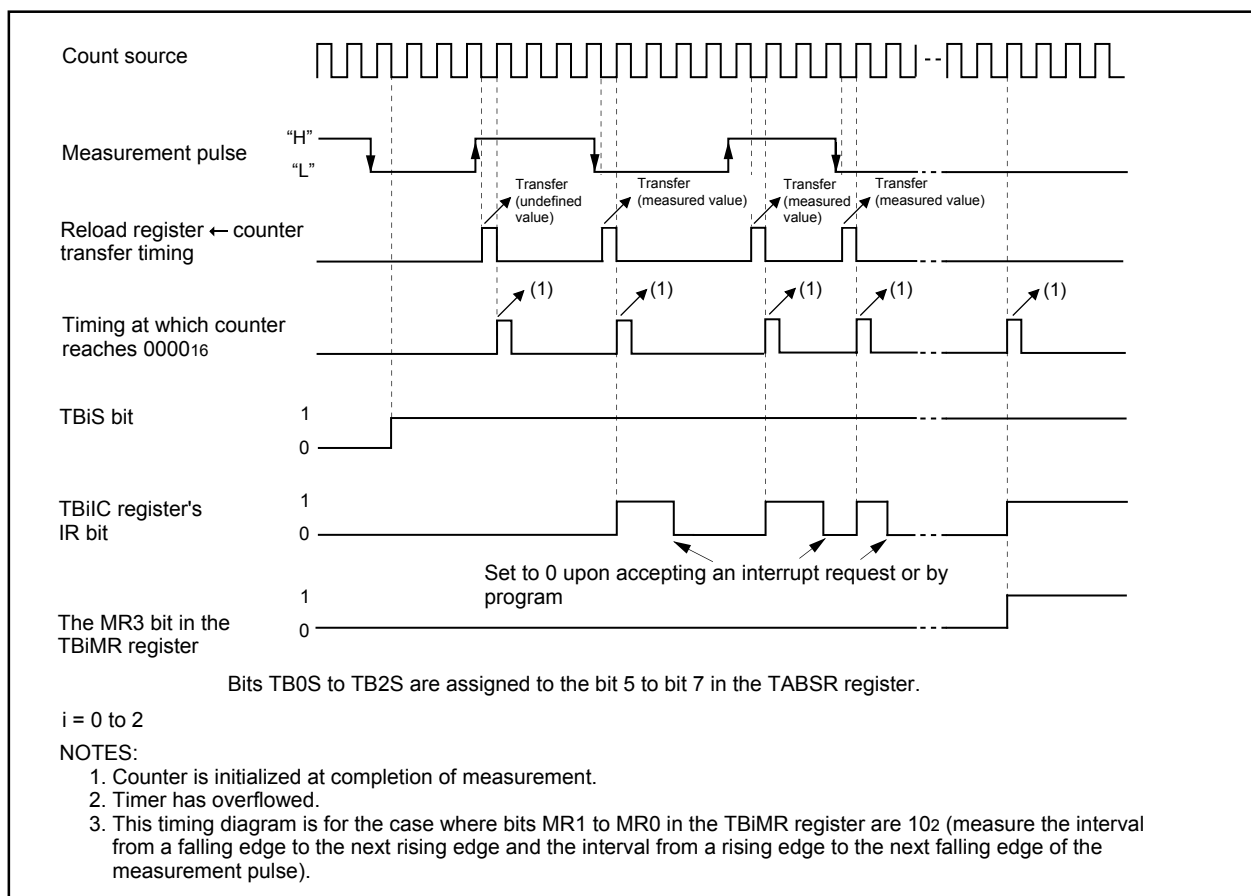


Figure 12.22 Operation timing when measuring a pulse width

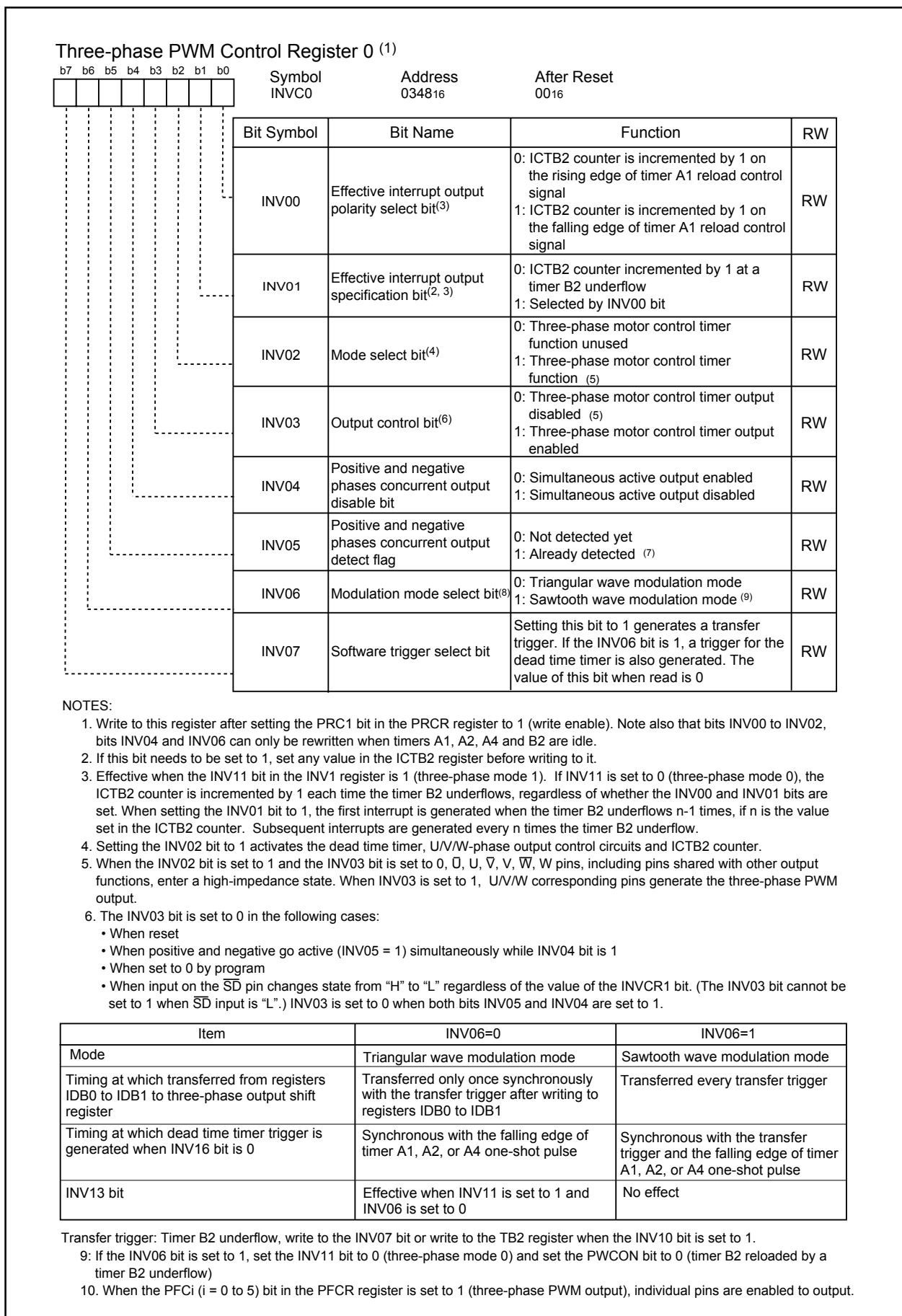


Figure 12.26 INVC0 Register

12.3.2 Three-phase/Port Output Switch Function

When the INVC03 bit in the INVC0 register set to 1 (Timer output enabled for three-phase motor control) and setting the PFCi (i=0 to 5) in the PFCR register to 0 (I/O port), the three-phase PWM output pin (U, \bar{U} , V, \bar{V} , W and \bar{W}) functions as I/O port. Each bit of the PFCi bits (i=0 to 5) is applicable for each one of three-phase PWM output pins. **Figure 12.37** shows the example of three-phase/port output switch function. **Figure 12.38** shows the PFCR register and the three-phase protect control register.

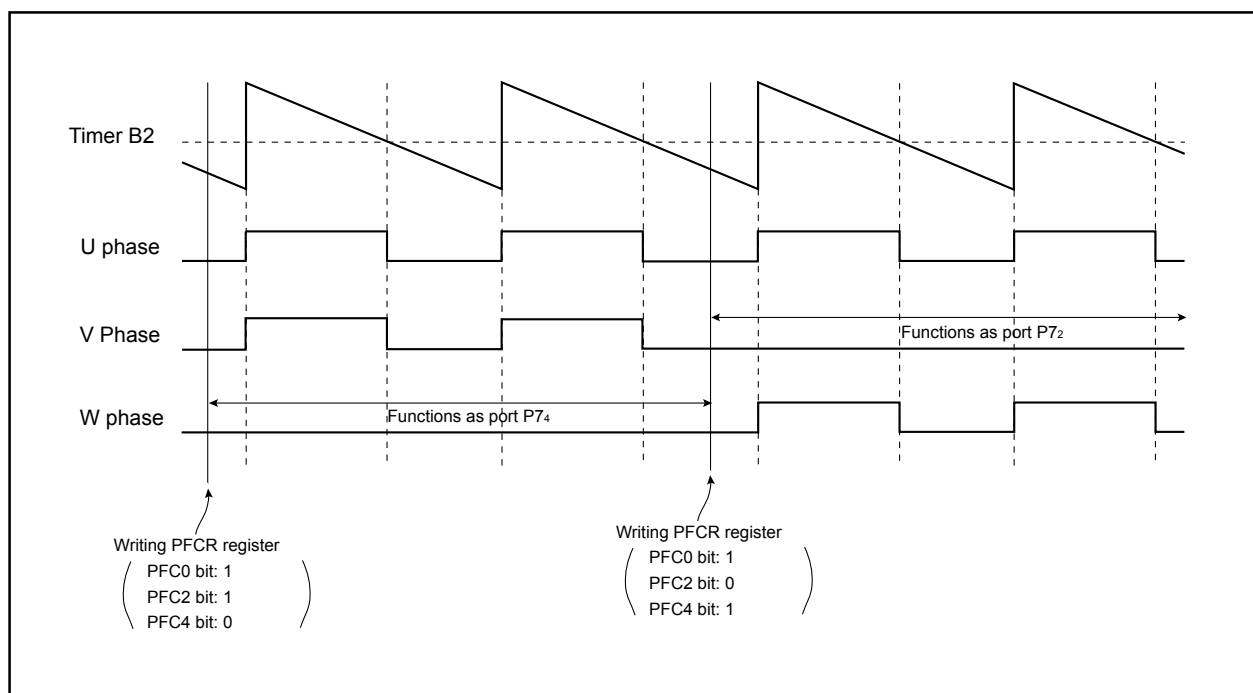


Figure 12.37 Usage Example of Three-phase/Port Output Switch Function

13.1.1 Base Timer Reset Register(G1BTRR)

The G1BTRR register provides the capability to reset the base timer when the base timer count value matches the value stored in the G1BTRR register. The G1BTRR register is enabled by the RST4 bit in the G1BCR0 register. This function is identical in operation to the G1PO0 base timer reset that is enabled by the RST1 bit in the G1BCR0 register. If the free-running operation is not selected, the channel 0 can be used for a waveform generation when the base timer is reset by the G1BTRR register. Do not enable bits RST1 and RST4 simultaneously.

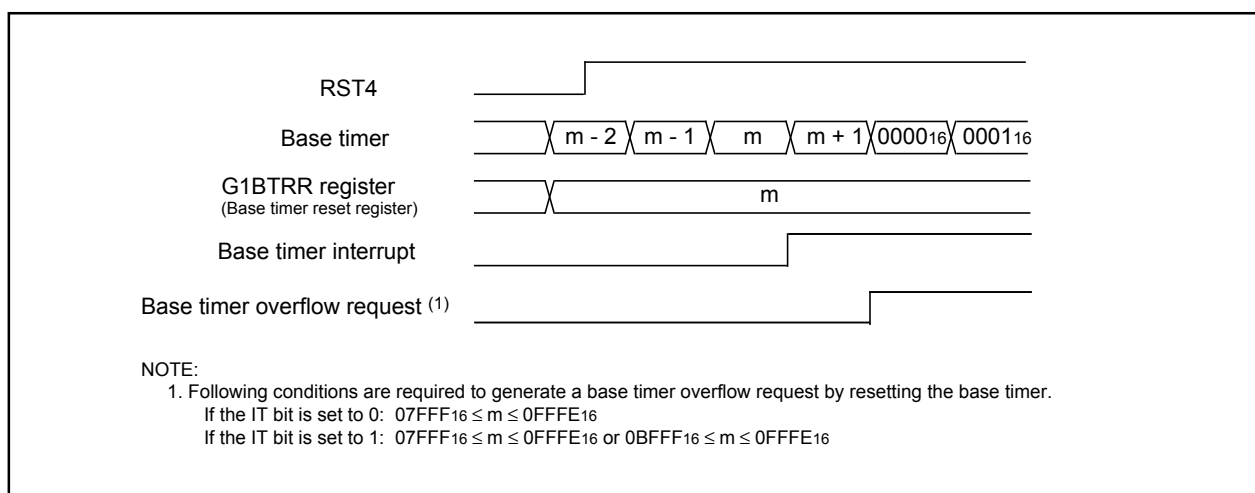


Figure 13.15 Base Timer Reset operation by Base Timer Reset Register

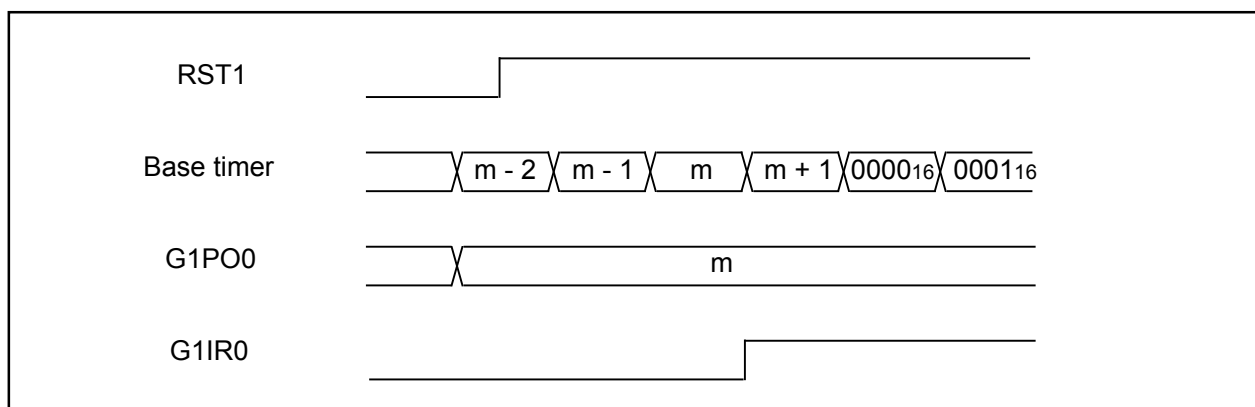


Figure 13.16 Base Timer Reset operation by G1PO0 register

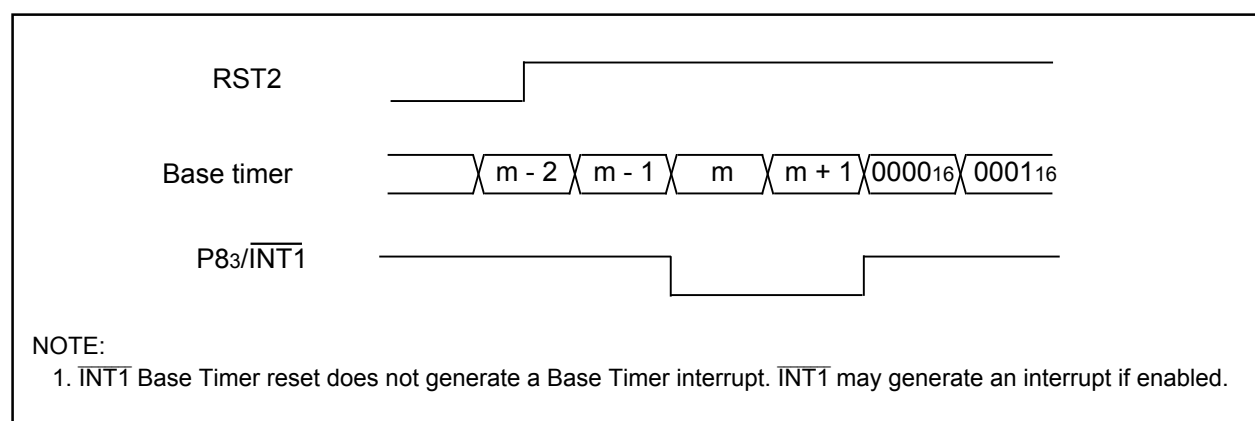


Figure 13.17 Base Timer Reset operation by INT1

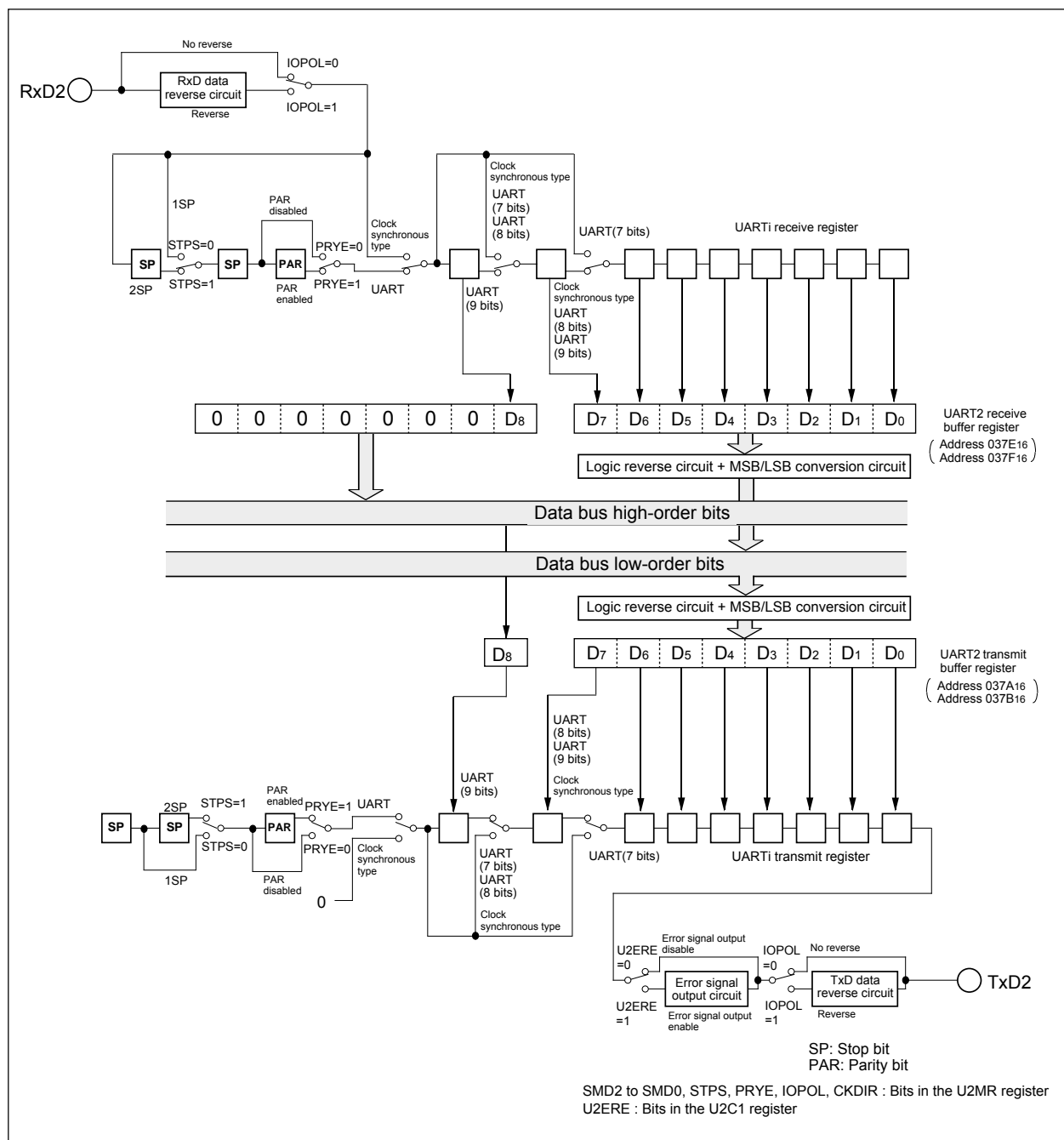


Figure 14.3 Block diagram of UART2 transmit/receive unit

14.1.2.4 Serial Data Logic Switching Function (UART2)

The data written to the U2TB register has its logic reversed before being transmitted. Similarly, the received data has its logic reversed when read from the U2RB register. **Figure 14.19** shows serial data logic.

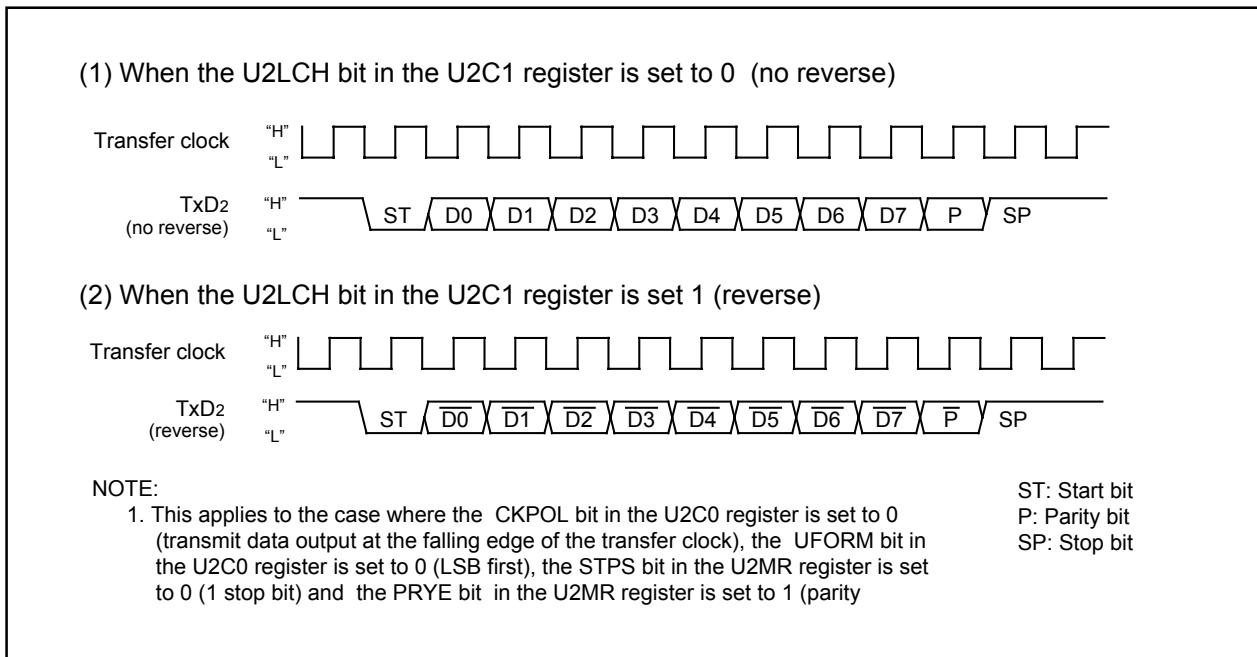


Figure 14.19 Serial Data Logic Switching

14.1.2.5 TxD and RxD I/O Polarity Inverse Function (UART2)

This function inverses the polarities of the TxD2 pin output and RxD2 pin input. The logic levels of all input/output data (including the start, stop and parity bits) are inverted. **Figure 14.20** shows the TxD pin output and RxD pin input polarity inverse.

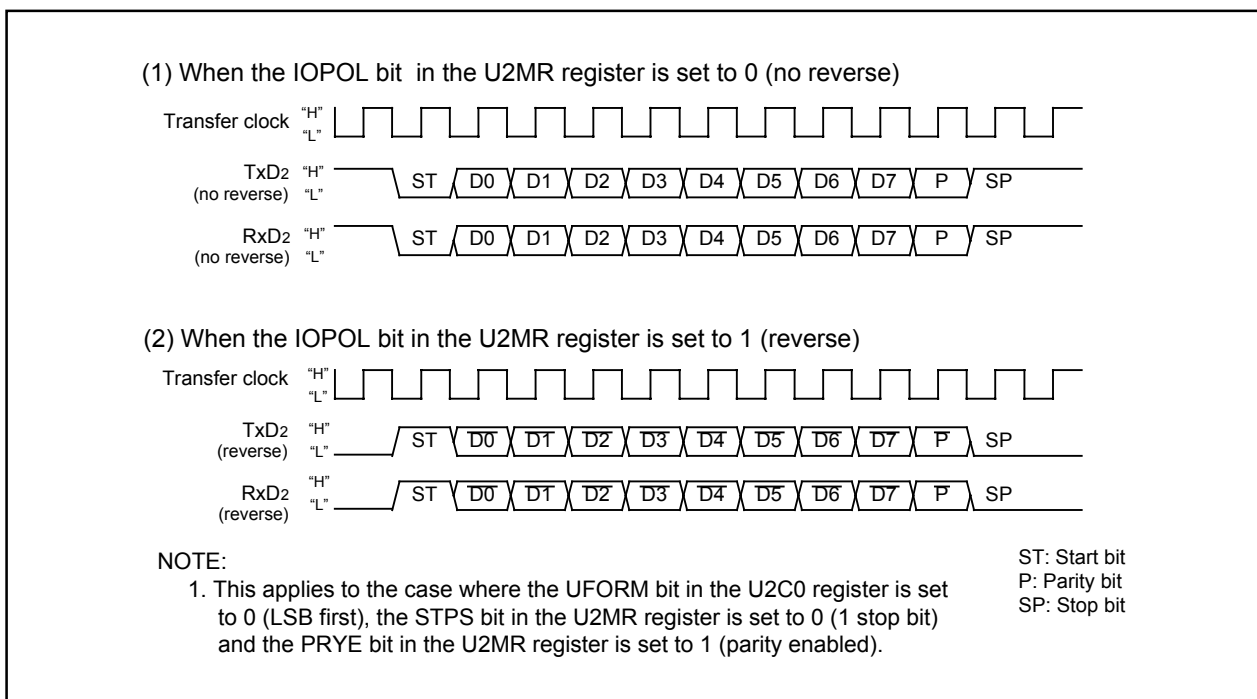


Figure 14.20 TxD and RxD I/O Polarity Inverse

15.1.7 Delayed Trigger Mode 0

In delayed trigger mode 0, analog voltages applied to the selected pins are converted one-by-one to a digital code. The delayed trigger mode 0 used in combination with A/D trigger mode of Timer B. The Timer B0 underflow starts a single sweep conversion. After completing the AN0 pin conversion, the AN1 pin is not sampled and converted until the Timer B1 underflow is generated. When the Timer B1 underflow is generated, the single sweep conversion is restarted with the AN1 pin. **Table 15.10** shows the delayed trigger mode 0 specifications. **Figure 15.19** shows the operation example in delayed trigger mode 0. **Figures 15.20** and **15.21** show each flag operation in the ADSTAT0 register that corresponds to the operation example. **Figure 15.22** shows registers ADCON0 to ADCON2 in delayed trigger mode 0. **Figure 15.23** shows the ADTRGCON register in delayed trigger mode 0 and **Table 15.11** shows the trigger select bit setting in delayed trigger mode 0.

Table 15.10 Delayed Trigger Mode 0 Specifications

Item	Specification
Function	Bits SCAN1 and SCAN0 in the ADCON1 register and bits ADGSEL1 and ADGSEL0 in the ADCON2 register select pins. Analog voltage applied to the input voltage of the selected pins are converted one-by-one to the digital code. At this time, timer B0 underflow generation starts AN0 pin conversion. Timer B1 underflow generation starts conversion after the AN1 pin. ⁽¹⁾
A/D Conversion Start	AN0 pin conversion start condition <ul style="list-style-type: none"> •When Timer B0 underflow is generated if Timer B0 underflow is generated again before Timer B1 underflow is generated, the conversion is not affected •When Timer B0 underflow is generated during A/D conversion of pins after the AN1 pin, conversion is halted and the sweep is restarted from the AN0 pin again AN1 pin conversion start condition <ul style="list-style-type: none"> •When Timer B1 underflow is generated during A/D conversion of the AN0 pin, the input voltage of the AN1 pin is sampled. The AN1 conversion and the rest of the sweep start when AN0 conversion is completed.
A/D Conversion Stop Condition	<ul style="list-style-type: none"> •When single sweep conversion from the AN0 pin is completed •Set the ADST bit to 0 (A/D conversion halted)⁽²⁾
Interrupt request generation timing	A/D conversion completed
Analog input pin	Select from AN0 to AN1 (2 pins), AN0 to AN3 (4 pins), AN0 to AN5 (6 pins) and AN0 to AN7 (8 pins) ⁽³⁾
Readout of A/D conversion result	Readout one of registers AN0 to AN7 that corresponds to the selected pins

NOTES:

1. Set the larger value than the value of the timer B0 register to the timer B1 register. The count source for timer B0 and timer B1 must be the same.
2. Do not write 1 (A/D conversion started) to the ADST bit in delayed trigger mode 0. When write 1, unexpected interrupts may be generated.
3. AN0 to AN07, AN 2 to AN27, and AN30 to AN32 can be used in the same way as AN0 to AN7. However, all input pins need to belong to the same group.

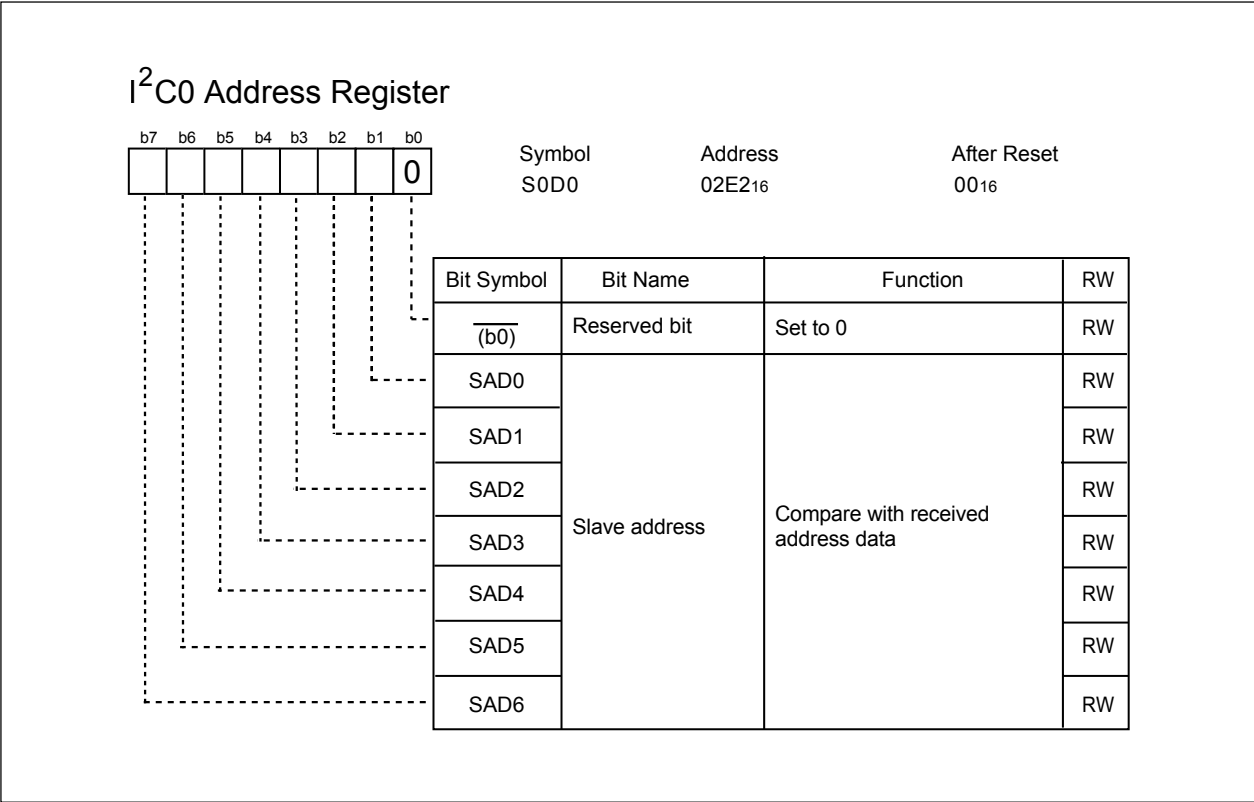


Figure 16.2 S0D0 Register

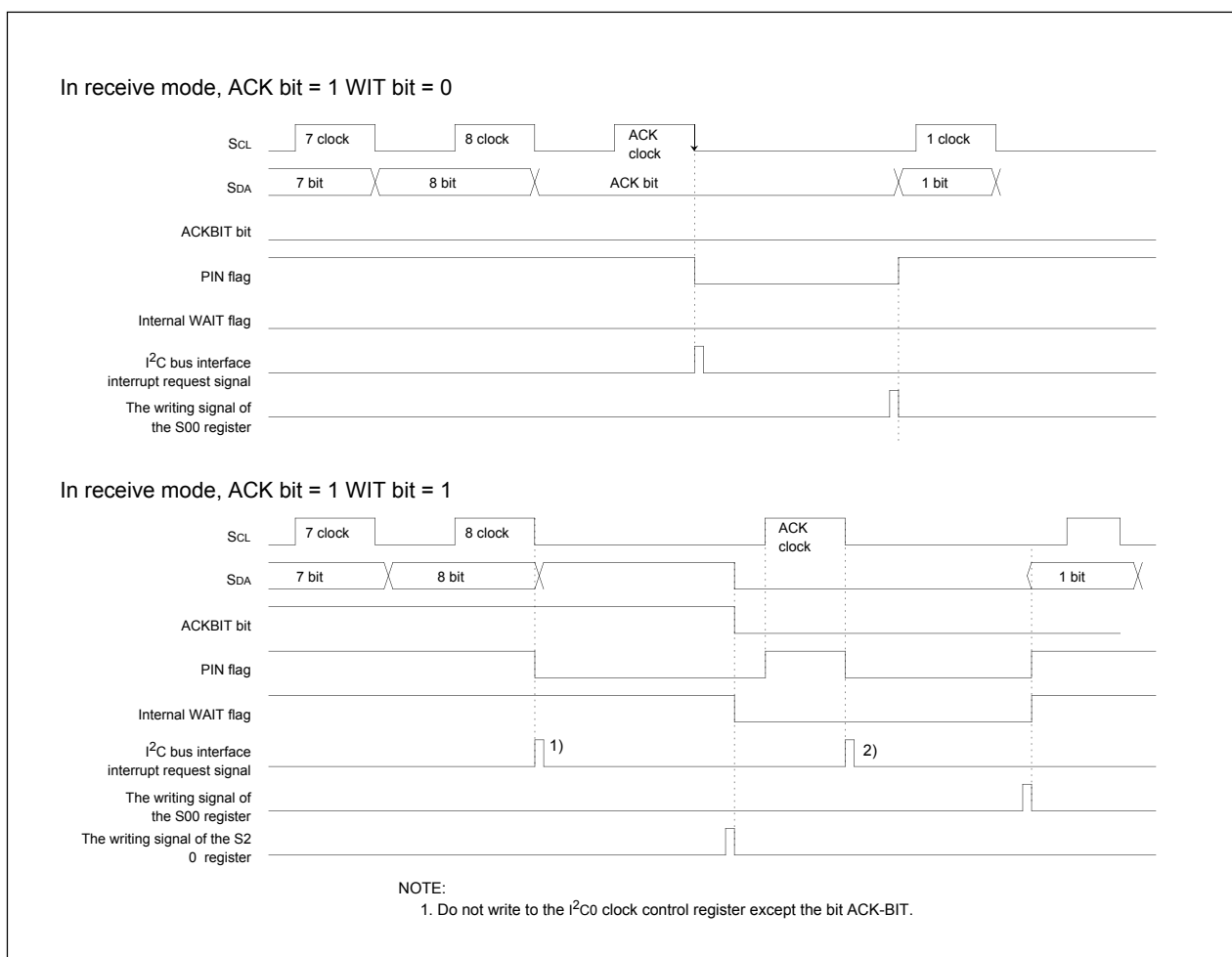


Figure 16.12 The timing of the interrupt generation at the completion of the data receive

16.6.3 Bits 2,3 : Port Function Select Bits PED, PEC

If the ES0 bit in the S1D0 register is set to 1 (I²C bus interface enabled), the SDAMM functions as an output port. When the PED bit is set to 1 and the SCLMM functions as an output port when the PEC bit is set to 1. Then the setting values of bits P2_0 and P2_1 in the port P2 register are output to the I²C bus, regardless of the internal SCL/SDA output signals. (SCL/SDA pins are connected to I²C bus interface circuit)

The bus data can be read by reading the port pi direction register in input mode, regardless of the setting values of the PED and PEC bits. **Table 16.5** shows the port specification.

Table 16.5 Port specifications

Pin Name	ES9 Bit	PED Bit	P20 Port Direction Register	Function
P20	0	-	0/1	Port I/O function
	1	0	-	SDA I/O function
	1	1	-	SDA input function, port output function
Pin Name	ES0 Bit	PEC Bit	P21 Port Direction Register	Function
P21	0	-	0/1	Port I/O function
	1	0	-	SCL I/O function
	1	1	-	SCL input function, port output function

20.7 Software Commands

Read or write 16-bit commands and data from or to even addresses in the user ROM area. When writing a command code, 8 high-order bits (D15–D8) are ignored.

Table 20.5 Software Commands

Command	First bus cycle			Second bus cycle		
	Mode	Address	Data (D15 to D0)	Mode	Address	Data (D15 to D0)
Read array	Write	X	xxFF ₁₆			
Read status register	Write	X	xx70 ₁₆	Read	X	SRD
Clear status register	Write	X	xx50 ₁₆			
Program	Write	WA	xx40 ₁₆	Write	WA	WD
Block erase	Write	X	xx20 ₁₆	Write	BA	xxD0 ₁₆

SRD: Status register data (D7 to D0)

WA : Write address (However, even address)

WD : Write data (16 bits)

BA : Highest-order block address (However, even address)

X : Any even address in the user ROM area

xx : 8 high-order bits of command code (ignored)

20.7.1 Read Array Command (FF₁₆)

The read array command reads the flash memory.

Read array mode is entered by writing command code xxFF₁₆ in the first bus cycle. Content of a specified address can be read in 16-bit unit after the next bus cycle. The MCU remains in read array mode until an another command is written. Therefore, contents of multiple addresses can be read consecutively.

20.7.2 Read Status Register Command (70₁₆)

The read status register command reads the status register.

By writing command code xx70₁₆ in the first bus cycle, the status register can be read in the second bus cycle (Refer to **20.8 Status Register**). Read an even address in the user ROM area. Do not execute this command in EW mode 1.

20.7.3 Clear Status Register Command (50₁₆)

The clear status register command clears the status register to 0.

By writing xx50₁₆ in the first bus cycle, and bits FMR06 to FMR07 in the FMR0 register and bits SR4 to SR5 in the status register are set to 0.

$$V_{CC} = 5V$$

Timing Requirements

($V_{CC} = 5V$, $V_{SS} = 0V$, at $T_{opr} = -20$ to $85^{\circ}C$ / -40 to $85^{\circ}C$ unless otherwise specified)

Table 21.17 Timer B Input (Counter Input in Event Counter Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiN input cycle time (counted on one edge)	100		ns
$t_{w(TBH)}$	TBiN input HIGH pulse width (counted on one edge)	40		ns
$t_{w(TBL)}$	TBiN input LOW pulse width (counted on one edge)	40		ns
$t_{c(TB)}$	TBiN input cycle time (counted on both edges)	200		ns
$t_{w(TBH)}$	TBiN input HIGH pulse width (counted on both edges)	80		ns
$t_{w(TBL)}$	TBiN input LOW pulse width (counted on both edges)	80		ns

Table 21.18 Timer B Input (Pulse Period Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiN input cycle time	400		ns
$t_{w(TBH)}$	TBiN input HIGH pulse width	200		ns
$t_{w(TBL)}$	TBiN input LOW pulse width	200		ns

Table 21.19 Timer B Input (Pulse Width Measurement Mode)

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(TB)}$	TBiN input cycle time	400		ns
$t_{w(TBH)}$	TBiN input HIGH pulse width	200		ns
$t_{w(TBL)}$	TBiN input LOW pulse width	200		ns

Table 21.20 A/D Trigger Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(AD)}$	ADTRG input cycle time (trigger able minimum)	1000		ns
$t_{w(ADL)}$	ADTRG input LOW pulse width	125		ns

Table 21.21 Serial I/O

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{c(CK)}$	CLKi input cycle time	200		ns
$t_{w(CKH)}$	CLKi input HIGH pulse width	100		ns
$t_{w(CKL)}$	CLKi input LOW pulse width	100		ns
$t_{d(C-Q)}$	TxDi output delay time		80	ns
$t_{h(C-Q)}$	TxDi hold time	0		ns
$t_{su(D-C)}$	RxDi input setup time	70		ns
$t_{h(C-D)}$	RxDi input hold time	90		ns

Table 21.22 External Interrupt INTi Input

Symbol	Parameter	Standard		Unit
		Min.	Max.	
$t_{w(INH)}$	INTi input HIGH pulse width	250		ns
$t_{w(INL)}$	INTi input LOW pulse width	250		ns

22.6.1.4 Timer A (Pulse Width Modulation Mode)

1. The timer remains idle after reset. Set the mode, count source, counter value, etc. using bits TA0TGL and TA0TGH in the TAI_iMR (i = 0 to 4) register, the TAI register, the ONSF register and the TRGSR register before setting the TAI_iS bit in the TABSR register to 1 (count starts).

Always make sure bits TA0TGL and TA0TGH in the TAI_iMR register, the ONSF register and the TRGSR register are modified while the TAI_iS bit remains 0 (count stops) regardless whether after reset or not.

2. The IR bit is set to 1 when setting a timer operation mode with any of the following procedures:

- Select the PWM mode after reset.
- Change an operation mode from timer mode to PWM mode.
- Change an operation mode from event counter mode to PWM mode.

To use the timer A_i interrupt (interrupt request bit), set the IR bit to 0 by program after the above listed changes have been made.

3. When setting TAI_iS register to 0 (count stop) during PWM pulse output, the following action occurs:

- Stop counting.
- When TAI_iOUT pin is output "H", output level is set to "L" and the IR bit is set to 1.
- When TAI_iOUT pin is output "L", both output level and the IR bit remains unchanged.

4. If a low-level signal is applied to the \overline{SD} pin when the IVPCR1 bit in the TB2SC register is set to 1 (three-phase output forcible cutoff by input on \overline{SD} pin enabled), the TA1_{OUT}, TA2_{OUT} and TA4_{OUT} pins go to a high-impedance state.

22.7.2 Rewrite the ICOCiIC Register

When the interrupt request to the ICOCiIC register is generated during the instruction process, the IR bit may not be set to 1 (interrupt requested) and the interrupt request may not be acknowledged. At that time, when the bit in the G1IR register is held to 1 (interrupt requested), the following IC/OC interrupt request will not be generated. When changing the ICOCiIC register setting, use the following instruction.

Subject instructions: AND, OR, BCLR, BSET

When initializing Timer S, change the ICOCiIC register setting with the request again after setting registers IOCiIC and G1IR to 0016.

22.7.3 Waveform Generating Function

1. If the BTS bit in the G1BCR1 register is set to 0 (base timer is reset) when the waveform is generating and the base timer is stopped counting, the waveform output pin keeps the same output level. The output level will be changed when the base timer and the G1POj register match the setting value next time after the base timer starts counting again.
2. If the G1POCRj register is set when the waveform is generated, the same setting value of the IVL bit is applied to the waveform generating pin. Do not set the G1POCRj register when the waveform is generating.
3. When the RST1 bit in the G1BCR1 register is set to 1 (the base timer is reset by matching the G1PO0 register), the base timer is reset after two clock cycles of fBT1 when the base timer value matches the G1PO0 register value. A high-level ("H") signal is applied to the OUTC10 pin between the base timer value match to the base timer reset.

22.7.4 IC/OC Base Timer Interrupt

If the MCU is operated in the combination selected from **Table 22.1** for use when the RST4 bit in the G1BCR0 register is set to 1 (reset the base timer that matches the G1BTRR register) to reset the base timer, an IC/OC base timer interrupt request is generated twice.

Table 22.1 Uses of IT Bit in the G1BCR0 Register and G1BTRR Register

IT Bit in the G1BCR0 Register	G1BTRR Register
0 (bit 15 in the base timer overflows)	07FFF ₁₆ to 0FFFE ₁₆
1 (bit 14 in the base timer overflows)	03FFF ₁₆ to 0FFFE ₁₆ or 0BFFF ₁₆ to 0FFFE ₁₆

The second IC/OC base timer interrupt request is generated because the base timer overflow request is generated after one fBT1 clock cycle as soon as the base timer is reset.

One of the following conditions must be met in order not to generate the IC/OC base timer interrupt request twice:

- 1) When the RST4 bit is set to 1, set the G1BTRR register with a combination other than what is listed in **Table 22.1**.
- 2) Do not reset the base timer by matching the G1BTRR register. Reset the base timer by matching the G1P00 register. In other words, do not set the RST4 bit to 1 to reset the base timer. Set the RST1 bit in the G1BCR1 register to 1 (reset the base timer that matches the G1P00 register).

REVISION HISTORY	M16C/29 Hardware Manual
------------------	-------------------------

Rev.	Date	Description	
		Page	Summary
		360	Table 21.1 is partly revised.
		368	Section “21.4.2 EW1 Mode” is partly revised.
0.80	Sep/03/Y04	2,3	Table 1.2.1 and Table 1.2.2 are partly revised.
		6,7	Table 1.4.1 to Table 1.4.3 are partly revised.
		7	Figure 1.4.1 is partly revised.
		8,9	Figure 1.5.1 and Figure 1.5.2 are partly revised.
		21	Figure 4.7 is partly revised.
		24	Figure 4.10 is partly revised.
		26	Section “5.1.2 Hardware Reset 2” is partly revised.
		29 to 34	Section “5.5 Voltage Detection Circuit” is revised.
		80	Section “10.2 Cold start / Warm start” is added.
		322	Table 20.2 is partly revised.
		323	Table 20.3 is partly revised.
		325	Table 20.6 and Table 20.7 are partly revised.
		327	Table 20.9 is partly revised.
		331	Title of Table 20.23 is partly revised.
		335	Table 20.25 is partly revised.
		339	Title of Table 20.39 is partly revised.
		343	Table 20.41 is partly revised.
		344	Table 20.42 is partly revised.
		346	“Low Voltage Detection Circuit Electrical Characteristics” is deleted.
			Table 20.45 is partly revised.
		348	Table 20.47 is partly revised.
		352	Title of Table 20.61 is partly revised.
		356	Table 20.63 is partly revised.
		360	Title of Table 20.77 is partly revised.
		398	64P6Q-A package is revised.
1.00	Nov/01/Y04	All pages	Words standardized (on-chip oscillator, A/D)
		2, 3	Table 1.2.1 and Table 1.2.2 are partly revised.
		8, 9	Table 1.4.4 to 1.4.6 and figure 1.4.2 to 1.4.6 are added.
		28	“5.1.2 Hardware Reset 2” is partly revised.
		29	“5.4 Oscillation Stop Detection Reset” is partly revised.
		38	Table 7.1 is partly revised.
		41	Note 6 in Figure 7.3 is partly revised. b7 to b4 bit in Figure 7.4 is revised.
		42	Figure 7.5 is partly revised.
		43	“PCLKR register” in Figure 7.6 is partly revised.
		50	“7.6.1 Normal Operation Mode” is partly revised.
		51	Note 1 in Table 7.6.1.1 is partly revised.
		57	“7.8 Oscillation Stop and Re-oscillation Detect Function” is partly revised.

REVISION HISTORY

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Rev.	Date	Description	
		Page	Summary
		9 19, 20	<ul style="list-style-type: none"> • Tables 1.6 to 1.8 Product Codes modified • Table 1.14 Pin Description pin description on I/O ports modified
		37	Reset <ul style="list-style-type: none"> • Figure 5.2 Reset Sequence Vcc and ROC timings modified
		45	Processor Mode <ul style="list-style-type: none"> • Figure 6.2 PM2 Register Description on notes 5 and 6 modified
		52 64	Clock Generation Circuit <ul style="list-style-type: none"> • Figure 7.6 PM2 Register Description on notes 5 and 6 modified • Figure 7.12 State Transition in Normal Mode note 2 modified
		69	Protection <ul style="list-style-type: none"> • Description on protection modified • Figure 8.1 PRCR Register note 1 modified
		88	Interrupts <ul style="list-style-type: none"> • Table 9.6 PC Value Saved in Stack Area When Address Match Interrupt Request I Acknowledged instruction modified
		90	Watchdog Timer <ul style="list-style-type: none"> • Figure 10.2 WDTS Register modified • 10.1 Count Source Protective Mode description modified
		129	Timer <ul style="list-style-type: none"> • Figure 12.28 ICTB2 Register modified
		256	Multi-Master I²C bus Interface <ul style="list-style-type: none"> • Figure 16.1 Block Diagram of Multi-Master I²C bus Interface modified
		335 340 341 343	Flash Memory Version <ul style="list-style-type: none"> • 20.3.1 ROM Code Protect Function register name modified • 20.5.2 Flash Memory Control Register 1 description on FMR17 bit modified • Figure 20.6 FMR1 Register note 2 modified • Figure 20.9 Setting and Resetting of EW Mode 1 modified
		369 370 372 380 390 391 393	Electrical Characteristics <ul style="list-style-type: none"> • Table 21.5 Flash Memory Version Electrical Characteristics note 10 modified • Timing figure for td(P-R) and td(ROC) modified • Table 21.9 Electrical Characteristics parameter and measurement condition modified, note 5 deleted • Table 21.25 Electrical Characteristics measurement condition modified, note 5 deleted • Tables 21.43 and 44 Flash Memory Version Electrical Characteristics note 10 modified • Timing figure for td(P-R) and td(ROC) modified • Table 21.47 Electrical Characteristics parameter and condition modified, note